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#### Understanding <u>Embedded - CPLDs (Complex</u> <u>Programmable Logic Devices)</u>

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixedfunction ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

#### Applications of Embedded - CPLDs

#### Details

Product Status	Obsolete
Programmable Type	In System Programmable
Delay Time tpd(1) Max	24 ns
Voltage Supply - Internal	4.75V ~ 5.25V
Number of Logic Elements/Blocks	48
Number of Macrocells	192
Number of Gates	8000
Number of I/O	96
Operating Temperature	0°C ~ 70°C (TA)
Mounting Type	Surface Mount
Package / Case	128-BQFP
Supplier Device Package	128-PQFP (28x28)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/isplsi-1048c-50lq

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# ispLSI<sup>®</sup> 1048C Device Datasheet

September 2010

# **All Devices Discontinued!**

Product Change Notifications (PCNs) have been issued to discontinue all devices in this data sheet.

The original datasheet pages have not been modified and do not reflect those changes. Please refer to the table below for reference PCN and current product status.

Product Line	Ordering Part Number	Product Status	Reference PCN
	ispLSI 1048C-50LQ		
	ispLSI 1048C-70LQ		PCN#13-10
ispLSI 1048C	ispLSI 1048C-50LQI	Discontinued	
	ispLSI 1048C-50LG/883		
	5962-9558701MXC		<u>PCN#05A-10</u>



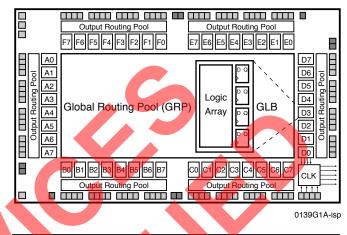
# ispLSI<sup>®</sup> 1048C

In-System Programmable High Density PLD

#### Features

- HIGH-DENSITY PROGRAMMABLE LOGIC
  - 8000 PLD Gates
  - 96 I/O Pins, 12 Dedicated Inputs, 2 Global Output Enables
  - 288 Registers
  - High-Speed Global Interconnect
  - Wide Input Gating for Fast Counters, State Machines, Address Decoders, etc.
  - Small Logic Block Size for Random Logic
  - Security Cell Prevents Unauthorized Copying
- HIGH PERFORMANCE E<sup>2</sup>CMOS<sup>®</sup> TECHNOLOGY
- fmax = 70 MHz Maximum Operating Frequency
- fmax = 50 MHz for Industrial and Military/883 Devices
- tpd = 16 ns Propagation Delay
- TTL Compatible Inputs and Outputs
- Electrically Erasable and Reprogrammable
- Non-Volatile E<sup>2</sup>CMOS Technology
- 100% Tested at Time of Manufacture
- IN-SYSTEM PROGRAMMABLE
  - In-System Programmable™ (ISP™) 5-Volt Only
  - Increased Manufacturing Yields, Reduced Time-to-Market, and Improved Product Quality
  - Reprogram Soldered Devices for Faster Debugging
- COMBINES EASE OF USE AND THE FAST SYSTEM SPEED OF PLDs WITH THE DENSITY AND FLEX-IBILITY OF FIELD PROGRAMMABLE GATE ARRAYS
- Complete Programmable Device Can Combine Glue Logic and Structured Designs
- Four Dedicated Clock Input Pins
- Synchronous and Asynchronous Clocks
- Flexible Pin Placement
- Optimized Global Routing Pool Provides Global Interconnectivity

#### Functional Block Diagram



#### Description

The ispLSI 1048C is a High-Density Programmable Logic Device containing 288 Registers, 96 Universal I/O pins, 12 Dedicated Input pins, two Global Output Enables (GOE), four Dedicated Clock Input pins and a Global Routing Pool (GRP). The GRP provides complete interconnectivity between all of these elements. The ispLSI 1048C features 5-Volt in-system programming and in-system diagnostic capabilities. It is the first device which offers non-volatile reprogrammability of the logic, and the interconnect to provide truly reconfigurable systems. Compared to the ispLSI 1048, the ispLSI 1048C offers two additional dedicated inputs and two new Global Output Enable pins.

The basic unit of logic on the ispLSI 1048C device is the Generic Logic Block (GLB). The GLBs are labeled A0, A1 .. F7 in figure 1. There are a total of 48 GLBs in the ispLSI 1048C devices. Each GLB has 18 inputs, a programmable AND/OR/XOR array, and four outputs which can be configured to be either combinatorial or registered. Inputs to the GLB come from the GRP and dedicated inputs. All of the GLB outputs are brought back into the GRP so that they can be connected to the inputs of any other GLB on the device.

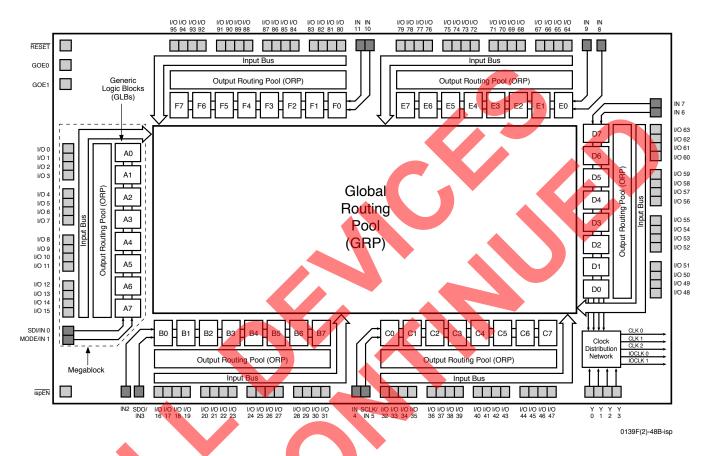
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LATTICE SEMICONDUCTOR CORP., 5555 Northeast Moore Ct., Hillsboro, Oregon 97124, U.S.A. Tel. (503) 268-8000; 1-800-LATTICE; FAX (503) 268-8556; http://www.latticesemi.com



#### Functional Block Diagram

#### Figure 1. ispLSI 1048C Functional Block Diagram



The device also has a 96 I/O cells, each of which is directly connected to an I/O pin. Each I/O cell can be individually programmed to be a combinatorial input, registered input, latched input, output or bi-directional I/O pin with 3-state control. Additionally, all outputs have selectable polarity, active high or active low. The signal voltage levels are TTL-compatible, and the output drivers can source 4 mA or sink 8 mA.

Eight GLBs, 16 I/O cells, two dedicated inputs and one ORP are connected together to make a Megablock as shown in figure 1. The outputs of the eight GLBs are connected to a set of 16 universal I/O cells by the ORP. Each ispLSI 1048C device contains six Megablocks.

The GRP has, as its inputs, the outputs from all of the GLBs and all of the inputs from the bi-directional I/O cells. All of these signals are made available to the inputs of the GLBs. Delays through the GRP have been equalized to minimize timing skew.

Clocks in the ispLSI 1048C device are selected using the Clock Distribution Network. Four dedicated clock pins (Y0, Y1, Y2 and Y3) are brought into the distribution network, and five clock outputs (CLK 0, CLK 1, CLK 2, IOCLK 0 and IOCLK 1) are provided to route clocks to the GLBs and I/O cells. The Clock Distribution Network can also be driven from a special clock GLB (D0 on the ispLSI 1048C device). The logic of this GLB allows the user to create an internal clock from a combination of internal signals.



#### Absolute Maximum Ratings 1

Supply Voltage V <sub>cc</sub> 0.5 to +7.0V	
Input Voltage Applied2.5 to V_{CC} +1.0V	
Off-State Output Voltage Applied2.5 to V_{CC} +1.0V	
Storage Temperature65 to 150°C	
Case Temp. with Power Applied55 to 125°C	

Max. Junction Temp. (TJ) with Power Applied ... 150°C

1. Stresses above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or at any other conditions above those indicated in the operational sections of this specification is not implied (while programming, follow the programming specifications).

#### DC Recommended Operating Conditions

SYMBOL	PARAMETER		MIN.	MAX.	UNITS
		Commercial $T_A = 0^{\circ}C$ to +70°C	4.75	5.25	
Vcc	Supply Voltage	Industrial $T_A = -40^{\circ}C$ to $+85^{\circ}C$	4.5	5.5	V
		Military/883 $T_c = -55^{\circ}C \text{ to } +125^{\circ}C$	4.5	5.5	
VIL	Input Low Voltage		0	0.8	V
<b>V</b> IH	Input High Voltage		2.0	Vcc + 1	V

Table 2- 0005Aisp w/mil.eps

### Capacitance ( $T_A = 25^{\circ}C_{1}$ f=1.0 MHz)

SYMBOL	PARAMETER		ΜΑΧΙΜυΊΛ	UNITS	TEST CONDITIONS
C <sub>1</sub>	Dedicated Input Capacitance	Commercial/Industrial	8	pf	V <sub>CC</sub> =5.0V, V <sub>IN</sub> =2.0V
	Dedicated input Capacitance	Military	10	pf	$V_{\rm CC}$ =5.0V, $V_{\rm IN}$ =2.0V
<b>C</b> <sub>2</sub>	I/O and Clock Capacitance		10	pf	$V_{cc}$ =5.0V, $V_{I/O}$ , $V_{Y}$ =2.0V

1. Characterized but not 100% tested.

Table 2- 0006

#### Data Retention Specifications

PARAMETER	MINIMUM	MAXIMUM	UNITS
Data Retention	20	_	Years
Erase/Reprogram Cycles	10000	—	Cycles

Table 2- 0008B



## Switching Test Conditions

Input Pulse Levels	GND to 3.0V
Input Rise and Fall Time	≤ 3ns 10% to 90%
Input Timing Reference Levels	1.5V
Output Timing Reference Levels	1.5V
Output Load	See figure 2

3-state levels are measured 0.5V from steady-state active level. Table 2- 0003

#### **Output Load Conditions (see figure 2)**

Tes	t Condition	R1	R2	CL
А		470Ω	390Ω	35pF
В	Active High	~	390Ω	35pF
	Active Low	470Ω	390Ω	35pF
С	Active High to Z at <b>V</b> <sub>OH</sub> - 0.5V	~	390Ω	5pF
	Active Low to Z at <b>V</b> <sub>OL</sub> + 0.5V	470Ω	390Ω	5pF
				Table 2- 0004A

Figure 2. Test Load

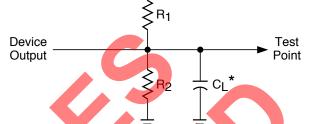
#### DC Electrical Characteristics

#### Over Recommended Operating Conditions

SYMBOL	PARAMETER	CONDI	ΓΙΟΝ	MIN.	<b>TYP.</b> <sup>3</sup>	MAX.	UNITS
VOL	Output Low Voltage	I <sub>oL</sub> =8 mA		_	_	0.4	V
<b>V</b> он	Output High Voltage	I <sub>он</sub> =-4 mA		2.4	_	-	V
lı∟	Input or I/O Low Leakage Current	-	-	-10	μA		
Ін	Input or I/O High Leakage Current	-	_	10	μΑ		
IL-isp	ispEN Input Low Leakage Current	$0V \le V_{IN} \le V_{IL} (MAX.)$		_	-	-150	μΑ
IL-PU	I/O Active Pull-Up Current	$0V \le V_{IN} \le V_{IL}$		_	-	-150	μΑ
OS1	Output Short Circuit Current	$V_{\rm CC} = 5V, V_{\rm OUT} = 0.5V$		-	-	-200	mA
CC <sup>2,4</sup>	Operating Power Supply Current	$V_{IL} = 0.5V, V_{IH} = 3.0V$	Commercial	-	165	235	mA
		f <sub>TOGGLE</sub> = 1 MHz	Industrial/Military	_	165	260	mA

1. One output at a time for a maximum duration of one second. V<sub>out</sub> = 0.5V was selected to avoid test problems by tester ground degradation. Characterized but not 100% tested.

2. Measured using twelve 16-bit counters.



CI includes Test Fixture and Probe Capacitance.

+ 5V

<sup>3.</sup> Typical values are at  $V_{cc} = 5V$  and  $T_A = 25^{\circ}C$ . 4. Maximum  $I_{cc}$  varies widely with specific device configuration and operating frequency. Refer to the Power Consumption section of this datasheet and Thermal Management section of the Lattice Semiconductor Data Book or CD-ROM to estimate maximum Table 2- 0007A-48-isp I<sub>cc</sub>.



## External Timing Parameters

PARAMETER	TEST 4	# <sup>2</sup>	DESCRIPTION <sup>1</sup>	-	70	-{	50	UNITS
	COND.	π		MIN.	MAX.	MIN.	MAX.	UNITS
<b>t</b> pd1	Α	1	Data Propagation Delay, 4PT bypass, ORP bypass	-	16.0	-	22.0	ns
<b>t</b> pd2	Α	2	Data Propagation Delay	-	19.0	-	26.0	ns
<b>f</b> max (Int.)	Α	3	Clock Frequency with Internal Feedback <sup>3</sup>	70.4	-	50.3	-	MHz
<b>f</b> max (Ext.)	_	4	Clock Frequency with External Feedback ( $\frac{1}{tsu2 + tco1}$ )	47.6	-	34.5	-	MHz
<b>f</b> max (Tog.)	_	5	Clock Frequency, Max Toggle ( 1/(twh + tw1))	83.3	-	58.8	-	MHz
<b>t</b> su1	_	6	GLB Reg. Setup Time before Clock, 4PT bypass	9.5	_	13.0	-	ns
tco1	Α	7	GLB Reg. Clock to Output Delay, ORP bypass	-	10.0	_	14.0	ns
<b>t</b> h1	_	8	GLB Reg. Hold Time after Clock, 4 PT bypass	0	-	0		ns
<b>t</b> su2	_	9	GLB Reg. Setup Time before Clock	11.0	K	15.0	-	ns
tco2	_	10	GLB Reg. Clock to Output Delay	_	11.5	-	16.0	ns
<b>t</b> h2	_	11	GLB Reg. Hold Time after Clock	0	-	0	-	ns
tr1	Α	12	Ext. Reset Pin to Output Delay		15.0	_	20.5	ns
trw1	_	13	Ext. Reset Pulse Duration	10.0	-	13.5	-	ns
<b>t</b> ptoeen	В	14	Input to Output Enable	-	20.0	-	27.5	ns
<b>t</b> ptoedis	С	15	Input to Output Disable	-	20.0	-	27.5	ns
<b>t</b> goeen	В	16	Global OE Output Enable	-	15.0	_	20.5	ns
<b>t</b> goedis	С	17	Global OE Output Disable	-	15.0	-	20.5	ns
<b>t</b> wh	_	20	Ext. Sync. Clock Pulse Duration, High	6.0	-	8.5	_	ns
twl	_	21	Ext. Sync. Clock Pulse Duration, Low	6.0	-	8.5	-	ns
<b>t</b> su3		22	I/O Reg. Setup Time before Ext. Sync. Clock (Y2, Y3)	2.0	-	3.0	-	ns
<b>t</b> h3		23	I/O Reg. Hold Time after Ext. Sync. Clock (Y2, Y3)	6.5	-	9.0	-	ns

Unless noted otherwise, all parameters use a GRP load of 4 GLBs, 20 PTXOR path, ORP and Y0 clock.
Refer to Timing Model in this data sheet for further details.
Standard 16-Bit counter using GRP feedback.

Table 2- 0030-48C/70, 50

4. Reference Switching Test Conditions section.



## Internal Timing Parameters<sup>1</sup>

PARAMETER	# <sup>2</sup>	DESCRIPTION	-	70	-50		UNITS
	#	DESCRIPTION	MIN.	MAX.	MIN.	MAX.	
Inputs		-	-				
tiobp	24	I/O Register Bypass	-	3.1	_	4.3	ns
<b>t</b> iolat	25	I/O Latch Delay	-	4.0	_	5.5	ns
tiosu	26	I/O Register Setup Time before Clock	6.5	-	9.1	-	ns
<b>t</b> ioh	27	I/O Register Hold Time after Clock	0.1	-	0.3	1	ns
tioco	28	I/O Register Clock to Out Delay	-	3.4	-	4.6	ns
tior	29	I/O Register Reset to Out Delay	-	3.7		5.1	ns
<b>t</b> din	30	Dedicated Input Delay	-	5.4	L	7.4	ns
GRP							-
<b>t</b> grp1	31	GRP Delay, 1 GLB Load		4.5	-	6.2	ns
<b>t</b> grp4	32	GRP Delay, 4 GLB Loads	-	4.9	_	6.7	ns
<b>t</b> grp8	33	GRP Delay, 8 GLB Loads	-	5.8	-	8.0	ns
<b>t</b> grp16	34	GRP Delay, 16 GLB Loads	-	7.6	-	10.5	ns
<b>t</b> grp48	35	GRP Delay, 48 GLB Loads	- 1	16.5	-	22.7	ns
GLB			_				
<b>t</b> 4ptbp	36	4 Product Term Bypass Path Delay	-	4.0	-	5.5	ns
<b>t</b> 1ptxor	37	1 Product Term/XOR Path Delay	-	4.9		6.7	ns
t20ptxor	38	20 Product Term/XOR Path Delay	-	5.5	-	7.5	ns
<b>t</b> xoradj	39	XOR Adjacent Path Delay <sup>3</sup>	-	6.5		8.9	ns
<b>t</b> gbp	40	GLB Register Bypass Delay	-	0.9	-	1.2	ns
<b>t</b> gsu	41	GLB Register Setup Time before Clock	2.9	-	3.9	-	ns
<b>t</b> gh	42	GLB Register Hold Time after Clock	5.3	-	7.3	-	ns
tgco	43	GLB Register Clock to Output Delay	-	1.5	-	2.3	ns
<b>t</b> gro	44	GLB Register Reset to Output Delay	-	2.1	-	2.8	ns
<b>t</b> ptre	45	GLB Product Term Reset to Register Delay	-	8.1	-	11.1	ns
<b>t</b> ptoe	46	GLB Product Term Output Enable to I/O Cell Delay		7.0	_	9.6	ns
<b>t</b> ptck	47	GLB Product Term Clock Delay	2.5	6.0	3.4	8.2	ns
ORP				1		, ,	
<b>t</b> orp	48	ORP Delay	-	2.5	-	3.4	ns
<b>t</b> orpbp	49	ORP Bypass Delay	-	1.0	-	1.4	ns

1. Internal Timing Parameters are not tested and are for reference only.

2. Refer to Timing Model in this data sheet for further details.

3. The XOR adjacent path can only be used by hard macros.

Table 2- 0036-48C/70, 50



# Internal Timing Parameters<sup>1</sup>

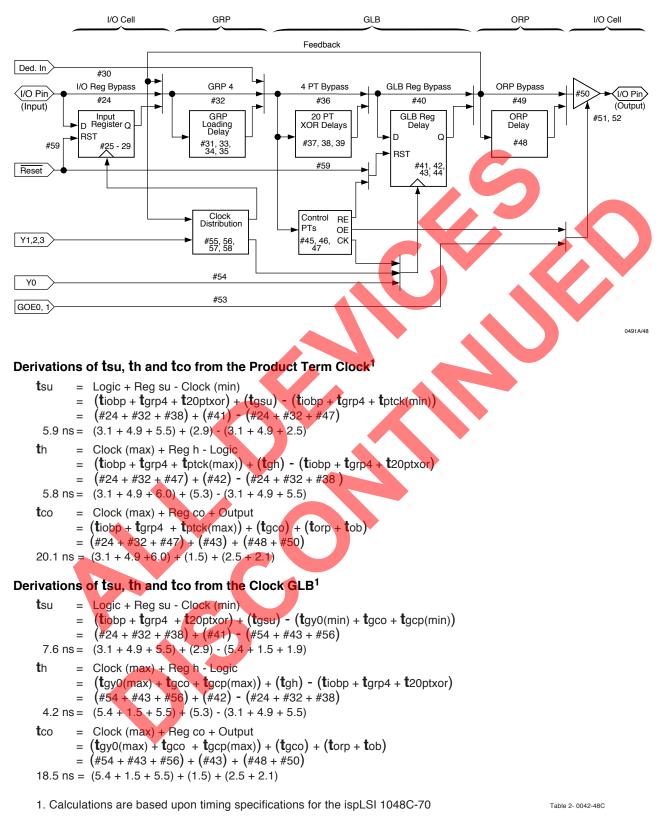
ispLSI 104	18C	Timing Model					
PARAMETER	<b>#</b> <sup>2</sup>	DESCRIPTION			-30		UNITS
			MIN.	MAX.	MIN.	MAX.	
Outputs							
<b>t</b> ob	50	Output Buffer Delay	-	2.1	-	2.9	ns
<b>t</b> oen	51	I/O Cell OE to Output Enabled	-	5.0	-	6.9	ns
todis	52	I/O Cell OE to Output Disabled		5.0	-	6.9	ns
tgoe	53	Global OE		10.0	-	13.6	ns
Clocks							
<b>t</b> gy0	54	Clock Delay, Y0 to Global GLB Clock Line (Ref. clock)	5.4	5.4	7.4	7.4	ns
<b>t</b> gy1/2	55	Clock Delay, Y1 or Y2 to Global GLB Clock Line	4.5	6.4	6.1	8.7	ns
<b>t</b> gcp	56	Clock Delay, Clock GLB to Global GLB Clock Line	1.9	5.5	2.6	7.6	ns
<b>t</b> ioy2/3	57	Clock Delay, Y2 or Y3 to I/O Cell Global Clock Line 4.5				8.7	ns
tiocp	58	Clock Delay, Clock GLB to I/O Cell Global Clock Line	1.9	5.5	2.6	7.6	ns
Global Re							
<b>t</b> gr	59	Global Reset to GLB and I/O Registers	-	8.3	_	11.4	ns

1. Internal Timing Parameters are not tested and are for reference only.

Table 2- 0037-48C/70, 50



# Specifications ispLSI 1048C





## Maximum GRP Delay vs GLB Loads

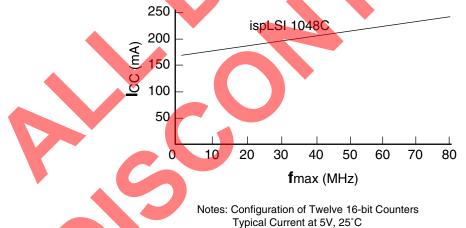


#### Power Consumption

Power consumption in the ispLSI 1048C device depends on two primary factors: the speed at which the device is operating, and the number of Product Terms used. Fig-

ure 3 shows the relationship between power and operating speed.





ICC can be estimated for the ispLSI 1048C using the following equation:

ICC = 73 + (# of PTs \* 0.23) + (# of nets \* Max. freq \* 0.010) where: # of PTs = Number of Product Terms used in design # of nets = Number of Signals used in device Max. freq = Highest Clock Frequency to the device

The I<sub>CC</sub> estimate is based on typical conditions (V<sub>CC</sub> = 5.0V, room temperature) and an assumption of 2 GLB loads on average exists. These values are for estimates only. Since the value of ICC is sensitive to operating conditions and the program in the device, the actual ICC should be verified.

0127A-48C-80-isp





tice

## Pin Description

NAME	PQFP PIN NUMBERS	DESCRIPTION
$\begin{array}{c} {\rm I/O}\ 0 \ - \ {\rm I/O}\ 5\\ {\rm I/O}\ 6 \ - \ {\rm I/O}\ 11\\ {\rm I/O}\ 12 \ - \ {\rm I/O}\ 17\\ {\rm I/O}\ 18 \ - \ {\rm I/O}\ 23\\ {\rm I/O}\ 24 \ - \ {\rm I/O}\ 29\\ {\rm I/O}\ 35\\ {\rm I/O}\ 36 \ - \ {\rm I/O}\ 35\\ {\rm I/O}\ 36 \ - \ {\rm I/O}\ 35\\ {\rm I/O}\ 35\\ {\rm I/O}\ 36 \ - \ {\rm I/O}\ 41\\ {\rm I/O}\ 42 \ - \ {\rm I/O}\ 47\\ {\rm I/O}\ 48 \ - \ {\rm I/O}\ 53\\ {\rm I/O}\ 54 \ - \ {\rm I/O}\ 59\\ {\rm I/O}\ 66 \ - \ {\rm I/O}\ 65\\ {\rm I/O}\ 66 \ - \ {\rm I/O}\ 71\\ {\rm I/O}\ 72 \ - \ {\rm I/O}\ 77\\ {\rm I/O}\ 78 \ - \ {\rm I/O}\ 83\\ {\rm I/O}\ 84 \ - \ {\rm I/O}\ 89\\ {\rm I/O}\ 90 \ - \ {\rm I/O}\ 95\end{array}$	21, 22, 23, 24, 25, 26 27, 28, 29, 30, 31, 32 34, 35, 36, 37, 38, 39 40, 41, 42, 43, 44, 45 52, 53, 54, 55, 56, 57 58, 59, 60, 61, 62, 63 66, 67, 68, 69, 70, 71 72, 73, 74, 75, 76, 77 85, 86, 87, 88, 89, 90 91, 92, 93, 94, 95, 96 98, 99,100,101,102, 103 104,105,106,107,108, 109 117,118,119,120,121, 122 123,124,125,126,127, 128 2, 3, 4, 5, 6, 7 8, 9, 10, 11, 12, 13	Input/Output Pins - These are the general purpose I/O pins used by the logic array.
GOE0, GOE1	64, 114	Global output enables for all I/Os.
IN 2, IN 4 IN 6 - IN 11	47, 51 84,110,111, 115,116, 14	Dedicated input pins to the device.
ispEN	18	Input – Dedicated in-system programming enable input pin. This pin is brought low to enable the programming mode. The MODE, SDI, SDO and SCLK options become active.
SDI/IN 01 MODE/IN 11		Input – This pin performs two functions. It is a dedicated input pin when ispEN is logic high. When ispEN is logic low, it functions as an input pin to load programming data into the device. SDI/IN 0 also is used as one of the two control pins for the isp state machine. Input – This pin performs two functions. It is a dedicated input pin when
		ispEN is logic high. When ispEN is logic low, it functions as a pin to control the operation of the isp state machine.
SDO/IN 31	50	Input/Output – This pin performs two functions. It is a dedicated input pin when ispEN is logic high. When ispEN is logic low, it functions as an output pin to read serial shift register data.
SCLK/IN 51	78	Input - This pin performs two functions. It is a dedicated input when ispEN is logic high. When ispEN is logic low, it functions as a clock pin for the Serial Shift Register.
RESET	19	Active Low (0) Reset pin which resets all of the GLB and I/O registers in the device.
YO	15	Dedicated Clock input. This clock input is connected to one of the clock inputs of all of the GLBs on the device.
Y1	83	Dedicated clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any GLB on the device.
Y2	80	Dedicated clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any GLB and/or any I/O cell on the device.
Y3	79	Dedicated clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any I/O cell on the device.
GND	1, 17, 33, 49, 65, 81 97, 112	Ground (GND)
VCC	16, 48, 82, 113	V <sub>cc</sub>

1. Pins have dual function capability.

Table 2- 0002C-48C





## Pin Description

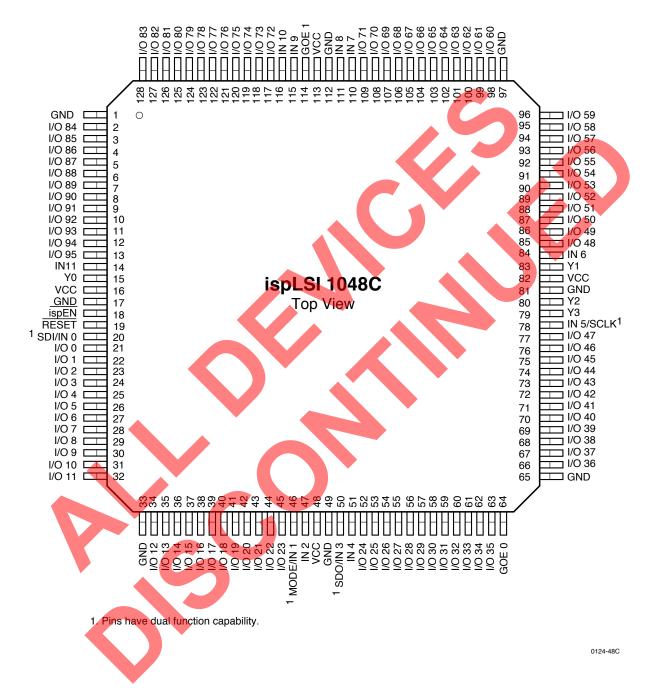
NAME	C	PGA	PIN I	NUME	BERS		DESCRIPTION
I/O 0 - I/O 5 I/O 6 - I/O 11 I/O 12 - I/O 17 I/O 18 - I/O 23 I/O 24 - I/O 29 I/O 30 - I/O 35 I/O 36 - I/O 41 I/O 42 - I/O 47 I/O 48 - I/O 53 I/O 54 - I/O 59 I/O 60 - I/O 65 I/O 66 - I/O 71 I/O 72 - I/O 77 I/O 78 - I/O 83 I/O 84 - I/O 89 I/O 90 - I/O 95	M12, L14, F13, D13, C12,	M9, M10, N14, K12, F12, E12, A13, C10, C6, C5, B1,	P13, M13, K13, E14, B14, B12, B10, A5, A2,	N12, L12, K14, D14, C13, C11, A10, A4, B3, D3,	K2, L3, P3, M6, N10, M11, J12, E13, D12, A12, C9, B5, C4, C1, F3,	P14, L13, J13, C14, A14,	Input/Output Pins - These are the general purpose I/O pins used by the logic array.
GOE0, GOE1	N13,	B7,					Global output enables for all I/Os.
IN 2, IN 4 IN 6 - IN 11	P7, F14,	P9 A9,	A8,	A7,	A6,	F1	Dedicated input pins to the device.
ispEN	H2						Input – Dedicated in-system programming enable input pin. This pin is brought low to enable the programming mode. The MODE SDI, SDO and SCLK options become active.
SDI/IN 0 <sup>1</sup> MODE/IN 1 <sup>1</sup>	J1 P6						Input – This pin performs two functions. It is a dedicated input pir when ispEN is logic high. When ispEN is logic low, it functions as an input pin to load programming data into the device. SDI/IN (also is used as one of the two control pins for the isp state machine Input – This pin performs two functions. It is a dedicated input pin
SDO/IN 31	P8						when ispEN is logic high. When ispEN is logic low, it functions as a pin to control the operation of the isp state machine. Input/Output – This pin performs two functions. It is a dedicated
SCLK/IN 51	J14						input pin when ispEN is logic high. When ispEN is logic low, i functions as an output pin to read serial shift register data. Input – This pin performs two functions. It is a dedicated inpu when ispEN is logic high. When ispEN is logic low, it functions as a clock pin for the Serial Shift Register.
RESET	H1						Active Low (0) Reset pin which resets all of the GLB and I/C registers in the device.
YO	G1					•	Dedicated Clock input. This clock input is connected to one of the clock inputs of all of the GLBs on the device.
Y1	G14						Dedicated clock input. This clock input is brought into the cloc distribution network, and can optionally be routed to any GLB of the device.
Y2	H13						Dedicated clock input. This clock input is brought into the cloc distribution network, and can optionally be routed to any GLB and or any I/O cell on the device.
Y3	H14						Dedicated clock input. This clock input is brought into the clock distribution network, and can optionally be routed to any I/O cell of the device.
GND	B2, M8,	B8, N2,	B13, N8	C8,	H3,	H12,	Ground (GND)
VCC	C7,	G2,		G12,	G13,	M7,	V <sub>cc</sub>

1. Pins have dual function capability.



Pin Configuration

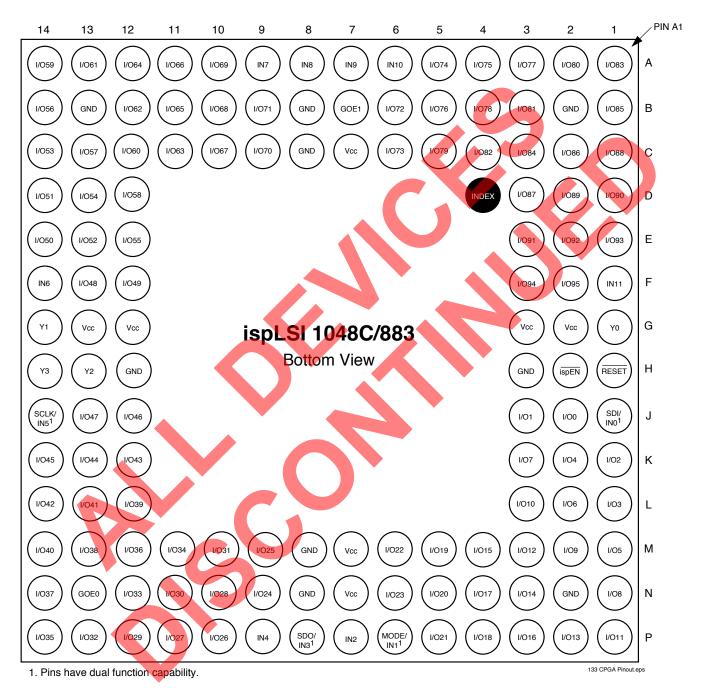
ispLSI 1048C 128-Pin PQFP Pinout Diagram





#### Pin Configuration

#### ispLSI 1048C 133-Pin CPGA Pinout Diagram





#### Part Number Description ispLSI 1048C - XX Х Х Х **Device Family** Grade Blank = Commercial I = Industrial **Device Number** /883 = 883 Military Process Package Speed Q = PQFP70 = 70 MHz **f**max G = CPGA50 = 50 MHz **f**max Power L = Low0212-80B-isp1048C Ordering Information COMMERCIAL **Ordering Number** Package Family fmax (MHz) tpd (ns) ispLSI 1048C-70LQ 128-Pin PQFP 70 16 ispLSI 50 22 ispLSI 1048C-50LQ 128-Pin PQFP INDUSTRIAL **Ordering Number** tpd (ns) Package Family fmax (MHz) 50 22 ispLSI 1048C-50LQI 128-Pin PQFP ispLSI MILITARY Family fmax (MHz) tpd (ns) Ordering Number **SMD Number** Package ispLSI 1048C-50LG/883 ispLSI 50 22 5962-9558701MXC 133-Pin CPGA Table 2- 0041A-48C-isp c